

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	STEFAN SCHMULT	07/10/2019
RECEIVING PARTY DATA		
Name:	TECHNISCHE UNIVERSITÄT DRESDEN	
Street Address:	HELMHOLTZSTRASSE 10	
City:	DRESDEN	
State/Country:	GERMANY	
Postal Code:	01069	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	16509022	
CORRESPONDENCE DATA		
Fax Number:		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Email:	jmd@usiplaw.com	
Correspondent Name:	EDELL SHAPIRO & FINNAN LLC	
Address Line 1:	9801 WASHINGTONIAN BLVD.	
Address Line 2:	SUITE 750	
Address Line 4:	GAITHERSBURG, MARYLAND 20878	
ATTORNEY DOCKET NUMBER:	1434.0007C	
NAME OF SUBMITTER:	PATRICK J. FINNAN	
SIGNATURE:	/Patrick J. Finnann/	
DATE SIGNED:	07/11/2019	
Total Attachments: 1		
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ASSIGNMENT

For good and valuable consideration, I, Stefan SCHMULT, a German citizen, residing at ,
Pohrsdorfer Weg 2, 01169 Dresden, Germany, hereinafter individually or collectively referred to as
"Assignor",

Hereby sell, assign and transfer to Technische Universität Dresden, a corporation organized
and existing under the laws of Germany, having a place of business at Helmholtzstrasse 10, 01069
Dresden, Germany, hereinafter "Assignee", its successors, assigns and legal representatives, the
entire right, title and interest in and for the United States and all foreign countries, in and to any and
all improvements which are disclosed in the application for United States Letters Patent, which has
been executed by the undersigned and

entitled: **Heterostructure Of An Electronic Circuit Having a Semiconductor Device**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other
applications for Letters Patent which have been or shall be filed in the United States and all foreign
countries on any of said improvements; and in and to all original and reissued patents which have been or
shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its
own name; and that, when requested, without charge to but at the expense of said Assignee, its
successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this
assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all
other patent applications on any and all said improvements, execute all rightful oaths, assignments,
powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal
representatives, all facts known to the undersigned relating to said improvements and the history thereof,
and generally do everything possible which said Assignee, its successors, assigns or legal representatives
shall consider desirable for aiding in securing and maintaining proper patent protection for said
improvements and for vesting title to said improvements and all applications for patents and all patents on
said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment,
grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been
made to others by the undersigned, and that full right to convey the same as herein expressed is possessed
by the undersigned.

SIGNATURE:


Stefan SCHMULT

DATE:

July 10th, 2019

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